



DATA SHEET

L Series

**

The L Series is a silicon MEMS piezoresistive pressure sensor. It is ideal for ultra-low-pressure applications

COMPANY: Merit Sensor is a leader in piezoresistive pressure sensing. We partner with clients to create high performing solutions for a variety of applications and industries.

SENTIUM: Merit Sensor products incorporate a proprietary Sentium® technology, developed to provide a best-in-class operating temperature range (-40°C to 150°C) and superior stability.

TECHNOLOGY: Merit Sensor utilizes a piezoresistive Wheatstone bridge in a design that anodically bonds glass to a chemically etched silicon diaphragm. All products are RoHS compliant.

CAPABILITIES: Merit Sensor designs, engineers, fabricates, dices, assembles, and tests products from a state-of-the-art facility near Salt Lake City, Utah.

FEATURES

Pressure 0.15 to 1 psi (1 to 6.89 kPa 10 to 68.95 mbar)

Range

Size 3.3 mm x 3.3 mm

Temperature Wide operating temperature range (up to 150°C)

Type Gage and differential

Media Clean, dry air and non-corrosive gases

Shipping Wafers on tape, waffle pack

Flexibility Sensitivity, resistance, bridge, etc.

BENEFITS

Performance Enjoy best-in-class performance due to Merit's

proprietary Sentium technology

Cost Save money over time with high-performing die

Security Feel confident doing business with an experienced

company backed by a solid parent company

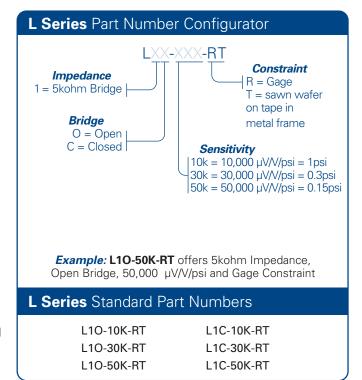
(NASDAQ: MMSI)

Speed Get to market quickly with creative and

flexible solutions

Service Experience prompt, personal, and

professional support



U.S. Patent Number 7,290,453

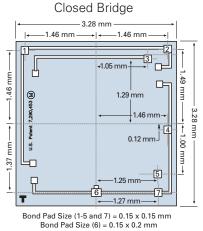


SPECIFICATIONS

Parameter	Minimum	Typical	Maximum	Units	Notes
Electrical & Environmental					
Excitation (In)		5	15	V	Maximum: 3 mA
Impedance	4000	5000	6000	Ω	
Operating Temperature	-40		150	°C	Sentium® technology
Storage Temperature	-55		160	°C	
Performance					
Offset	-10	0	10	mV/V	Zero Pressure; gage only; @25°C
Non-linearity	-0.25	0	0.25	% FSO	Best Fit Straight Line; @25°C
Pressure Hysteresis	-0.1	0	0.1	% FSO	@25°C
Temp Coeff – Zero	-20	0	20	μV/V/°C	-25°C to 75°C
Temp Coeff – Resistance	2000	2500	3000	PPM/°C	-25°C to 75°C
Temp Coeff – Sensitivity (0.15psi)	-2500	-3000	-3500	PPM/°C	-25°C to 75°C
Temp Coeff – Sensitivity (0.2psi – 1psi)	-2000	-2500	-3000	PPM/°C	-25°C to 75°C
Long-Term Stability	-0.25	0	0.25	% FSO	@125°C
Proof Pressure	5X				Full scale pressure
Burst Pressure	10psi				
Full-Scale Output (@ 5 volts excitation)					
1 psi (69 mbar; 6.9 kPa)	40	50	60	mV	Additional outputs available on request
0.3 psi (21 mbar; 2.1 kPa)	36	45	54	mV	
0.15 psi (10 mbar; 1 kPa)	30	37.5	60	mV	

DIMENSIONS (millimeters, post-cut)

Open Bridge 3.28 mm 2 ᆲ —1.37 mm 굅 1.37 mm-← 1.04 mm → ← 1.04 mm → Bond Pad Size = 0.15 x 0.2 mm



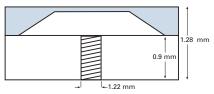
Open V_{+IN} V_{+IN} V_{+OUT} 1 6 V_{-OUT} 2 4 V_{-IN} V_{-IN} V_{+IN} V_{+IN} V_{+IN}

ELECTRICAL

4 7 6 Closed V_{+OUT} 3 5 V_{-OUT}

1 2 V_{-IN} V_{-IN}

Standard Bond Pad Metallization = Aluminum



Other constraints available

Note: Bridge output bond pad (V-out and V+out) correspond to top side pressure. For back side pressure, the bridge outputs are reversed.